

Title of Change:	Package Polyimide Tape Change	
Effective date:	27 Nov 2019	
Contact information:	Contact your local ON Semiconduct	or Sales Office or LengKian.See@onsemi.com
Type of notification:	This Product Bulletin is for notificat ON Semiconductor will proceed wit	ion purposes only. h implementation of this change upon publication of this Product Bulletin.
Change Category:	Assembly Change	
Change Sub-Category(s):	Material Change	
Sites Affected:		
ON Semiconductor Sites		External Foundry/Subcon Sites
ON Semiconductor Cebu, Phili	ppines	None
Description and Purpose:		
Unless otherwise indicated in affected products will remain	fully compliant to all published specifica	ucts listed below. fied change will not impact form, fit, or function of the products. The tions. Initial shipments lots, assembled with the type B polyimide tape were ters' arrangement. Full qualification testing was conducted in parallel with

Implementation of change:

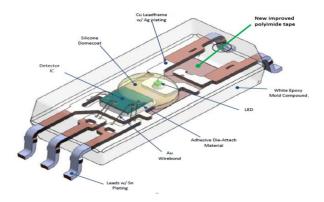
Expected First Shipment Date for Changed Product After Full Qualification : Dec 6, 2019

Expected First Date Code of Changed Product After Full Qualification: D1945

Description of Change (From) : Type A polyimide tape within the package.

Description of Change (To) : A new improved type B polyimide tape within the package.

Reason for Change: The identified change will improve the reliability and robustness of the products.



This change will take immediate effect on the issue date of this notification. Please contact your local Customer Quality Engineer if you require any additional data or clarifications



SOIC-5 Optocoupler PI Tape Qualification

Page 1 of	1	JEDEC IC Device S	emiconductor Con	ponent Qualification Sumn	nary			Rev. O
•		Supplier: ON Semiconductor Supplier PN: FOD8320R2V Product Description: GATE DRIVER OPTO Supplier Fab Info: MAINE FRONTEND (BSB) Supplier Assy Info: OSPI-CEBU BE (BSK)		Customer PN: General Specification: AEC Grade: Reliability Qualification Date: Family Type:	NA October 30	0, 2019	BF OS	ON Semiconductor"
Test	#	Reason for Qual: SOIC-5 Optocoupler Type B PolyIm Test Conditions	Reference	Comments	# Lots	S.S .	Results Fall/Total	Comments/ Test Results
Cost Crow		celerated Environment Stress Tests						
PC	A1	Preconditioning: SMD only; Moist. Precond.	JESD22 A113 J-STD-020	Performed on surface mount devices prior to UHAST & TC	3	154	0/462	MSL- 1 @ 260°C
UHAST	A2	Unblased Highly Accelerated Stress Test: 130°C/85% RH, ~ 18.8 psig, no blas for 96hrs.	JESD22 A118		3	77	0/231	
тс	A3	Temp Cycle: -40°C to +125°C; for 500 cycles	JESD22 A104		3	77	0/231	
HTSL	A4	High Temp Storage Life TA- 125°C for 1008 hrs	JESD22 A103		3	77	0/231	
est Grou	up B- A	celerated LifeTime Simulation Tests						
нтну	B1	High Temp High Voltage: TA=125°C; Blas=1kV for 1008 hrs.	JESD22 A108		3	30	0/90	Aging test has successfully completed with no anoma observed on the PI tape.
OTES:		Not recommended for Military, Medical or Aerospace Not for Automotive; Auto device may be available						

List of Affected Standard Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal**.

FOD8321	FOD8321R2	FOD8321R2V
FOD8321V	FOD8383	FOD8383R2
FOD8383R2V	FOD8383V	FOD8384
FOD8384R2	FOD8384R2V	FOD8384V
FOD8320	FOD8160R2	FOD8160
FOD8320V	FOD8320R2V	FOD8320R2
FOD8160V	FOD8160R2V	



ON

Product	Customer Part Number	Qualification Vehicle	New Part Number	Replacement Supplier
FOD8321		FOD8320R2V		
FOD8321R2		FOD8320R2V		
FOD8321R2V		FOD8320R2V		
FOD8321V		FOD8320R2V		
FOD8383		FOD8320R2V		
FOD8383R2V		FOD8320R2V		
FOD8383V		FOD8320R2V		
FOD8384		FOD8320R2V		
FOD8384R2		FOD8320R2V		
FOD8384V		FOD8320R2V		
FOD8320		FOD8320R2V		
FOD8160R2		FOD8320R2V		
FOD8160		FOD8320R2V		
FOD8320V		FOD8320R2V		
FOD8320R2V		FOD8320R2V		
FOD8320R2		FOD8320R2V		
FOD8160V		FOD8320R2V		
FOD8160R2V		FOD8320R2V		